# E-Cell Multi Series MSM65TN 6" Multi c-Si Solar Cell

## Meisongmao





- -Excellent electrical long-term stability and reliability by using of best raw materials and through strict quality inspection control.
- -Low breakage rate by using high qualified and stable wafers.
- -High quality homogeneous appearance by sorting into defined color classes.
- -100% screened for reverse current and shunt resistance.
- -Excellent solderability through high quality conductive materials and regular monitor soldering properties.

#### **Quality Control and Professional Service**

- -Regular calibration of test equipment using Fraunhofer ISE reference cell.
- -Environmental friendly due to REACH-SVHC and RoHS compliances.
- -Professional on-site service and support for module certification.
- -Regular light source AAA class calibration for stable conversion efficiency.
- -Lowest LID by periodic monitoring and superior wafer incoming control.

### **Physical Characteristics**

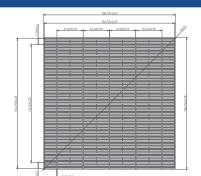
Dimensions	Dimension 156.75mm X 156.75mm±0.25mm				
Thickness(Si)	Thickness(Si) 180 μm±20 μm, 200μ m ±30 μr				
Front(-)	Acid texturized surface with Silicon nitride anti-reflecting coating				
	Color: Dark Blue, Blue, Sky Blue & Light Blue				
	5 X 0.7 mm ± 0.1 mm wide bus bars				
	Distance between bus bars : 31.2 mm				

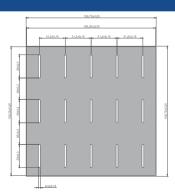
Back(+)

Aluminum back surface field

5x3 soldering pads,  $2 \text{ mm} \pm 0.15 \text{ mm}$  wide bus bars

Distance between bus bars: 31.2 mm





#### **Electrical Characteristics**

Efficiency Code		188	186	184	182	180	178	176
Efficiency	Eff(%)	18.80	18.60	18.40	18.20	18.00	17.80	17.60
Power	Pmpp(W)	4.62	4.57	4.52	4.47	4.42	4.37	4.32
Max. Power Current	Impp(A)	8.465	8.439	8.403	8.365	8.310	8.248	8.193
Short Circuit Current	Isc(A)	8.987	8.953	8.919	8.884	8.829	8.765	8.714
Max. Power Voltage	Vmpp(V)	0.546	0.542	0.538	0.535	0.532	0.530	0.528
Open Circuit Voltage	Voc(V)	0.640	0.637	0.633	0.630	0.628	0.627	0.625

Standard test condition: AM1.5, 1000W/m<sup>2</sup>, 25°c Average accuracy of all tests is +/-1.5% rel.





Current Temperature Coefficient	a(ISC)	0.05%/K
Voltage Temperature Coefficient	B(VOC)	-0.31%/K
Power Temperature Coefficient	γ(Pmax)	-0.38%/K

Standard test condition: AM1.5, 1000W/m2, 25°c

#### **Processing Recommendations**

Solder Joint

Copper ribbons coated with 15~25µm: 62%Sn/36%Pb/2%Ag or 60% Sn 40%Pb

Standard test condition: AM1.5, 1000W/m2, 25°c

#### Solderability

Peel Strength Minimum

>1.25 N/mm

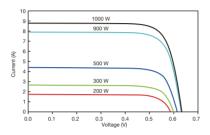
Soldering results may differ due to different flux, ribbons. soldering methods, and parameters.

#### **Qualifications and Certificates**

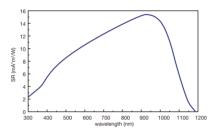


RoHS Compliance SVHC tested

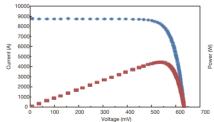
#### **Typical Current-Voltage Curve**



#### Typical Spectral Response

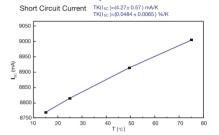


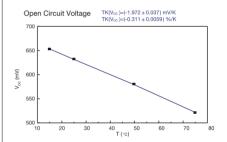
#### Typical IV-Power Curve

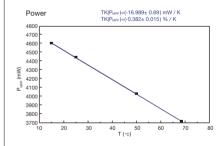


- \* All data measured under standard testing condition (STC): 1000 W/m2, AM 1.5, 25 °C.
- \* All figures bear ±2% tolerance. \* Reference cell calibrated by the Fraunhofer ISE in Freiburg.

#### **Calculated Temperature Coefficients**







#### **Meisongmao Corporation**